

Special Issue

Design, Development and Application of Microelectronics and Semiconductor Devices

Message from the Guest Editors

Research on innovative technologies for new materials and semiconductors has significantly increased, driven by the expansion of microprocessors, smart devices, sensors, and consumer electronics connected to the Internet of Things (IoT) in the digital era. The prospects are stimulating, but several challenges are emerging. One such challenge is related to the energy consumption of these devices, their speed, and reliability. The enhanced integration of new thin film technologies with VLSI has been suggested, as well as the development of novel transistors for the creation of modern circuits. Therefore, this collection considers recent advances in the design, modeling, fabrication, characterization, applications, and perspectives of microelectronic and semiconductor devices. It focuses on how these developments can address current and future challenges, promoting innovative solutions that optimize performance and energy efficiency, while exploring emerging applications across various fields of science and technology.

Guest Editors

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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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